TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3417

Switching Regulator Applications

- Reverse-recovery time: $t_{rr} = 60$ ns (typ.)
- Built-in high-speed flywheel diode
- Low drain-source ON resistance: $RDS(ON) = 1.6 \Omega$ (typ.)
- High forward transfer admittance: $|Y_{fs}| = 4.0 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 100 \ \mu A (max) (V_{DS} = 500 \ V)$
- Enhancement-model: $V_{th} = 2.0 \sim 4.0 \text{ V} (V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

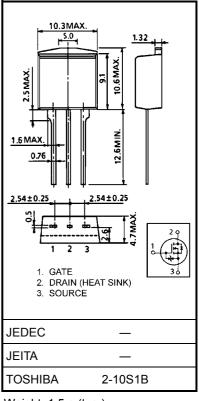
Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	500	V	
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V _{DGR}	500	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	I _D	5	А	
	Pulse (Note 1)	I _{DP}	20	~	
Drain power dissipat	ion (Tc = 25°C)	PD	50	W	
Single pulse avalanche energy (Note 2)		E _{AR}	180	mJ	
Avalanche current		I _{AR}	5	А	
Repetitive avalanche energy (Note 3)		E _{AR}	5	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	

Thermal Characteristics

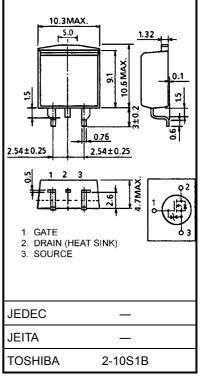
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	2.5	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

- Note 1: Please use devise on condition that the channel temperature is below 150°C.
- Note 2: V_{DD} = 90 V, T_{ch} = 25 ^{\circ}C (initial), L = 12.2 mH, R_G = 25 $\Omega,$ I_{AR} = 5 A
- Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 1.5 g (typ.)



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Unit: mm

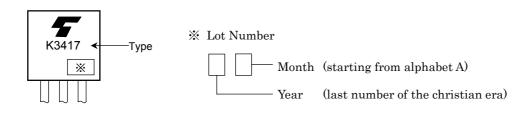
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS}=\pm 25~V,~V_{DS}=0~V$	_		±10	μA
Drain-source bre	akdown voltage	V (BR) GSS	$I_G=\pm 100~\mu\text{A},~V_{DS}=0~\text{V}$	±30			V
Drain cut-OFF cu	ırrent	I _{DSS}	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	_		100	μA
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	500			V
Gate threshold ve	oltage	V _{th}	$V_{DS} = 10 V, I_D = 1 mA$	2.0		4.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	_	1.6	1.8	Ω
Forward transfer	admittance	Y _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.5 \text{ A}$	2.5	4.0		S
Input capacitance		C _{iss}			780		pF
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	_	60		
Output capacitance		C _{oss}			200		
Switching time	Rise time	tr	$V_{GS}^{10 V} \downarrow I_D = 2.5 \text{ A } V_{OUT}$ $0 V \downarrow I_D = 2.5 \text{ A } V_{OUT}$ $R_L = 90 \Omega$ $V_{DD} \simeq 225 V$ $Duty \le 1\%, t_W = 10 \mu s$	_	12	_	
	Turn-ON time	t _{on}			25		
	Fall time	t _f			15		ns
	Turn-OFF time	t _{off}		_	60	_	
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq 400 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		17	_	nC
Gate-source charge		Q _{gs}			11		
Gate-drain ("miller") charge		Q _{gd}			6		

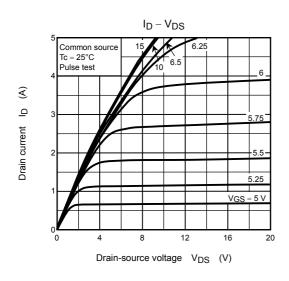
Source-Drain Ratings and Characteristics (Ta = 25°C)

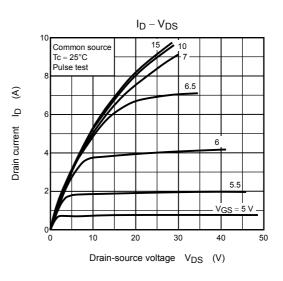
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—			5	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_		20	А
Forward voltage (diode)	V _{DSF}	I _{DR} = 5 A, V _{GS} = 0 V	_		-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 5 A, V _{GS} = 0 V,		60		ns
Reverse recovery charge	Q _{rr}	dI _{DR} /dt = 100 A/µs	_	0.1	_	μC

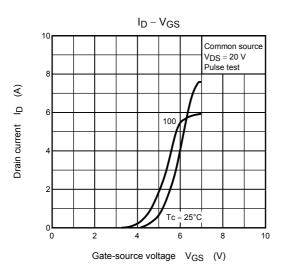
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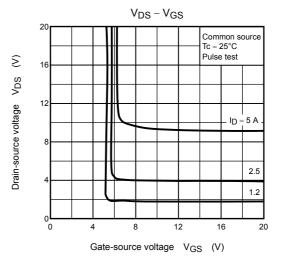


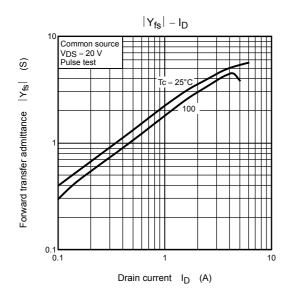
TOSHIBA



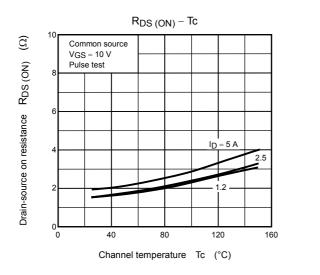


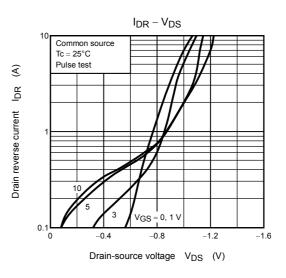


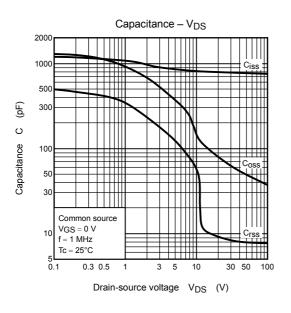


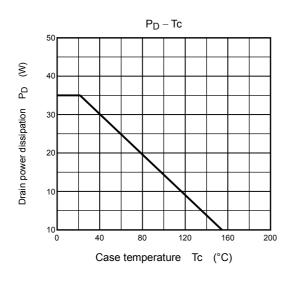


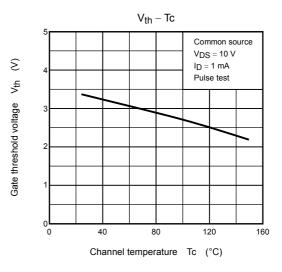
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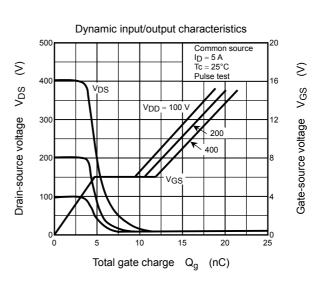


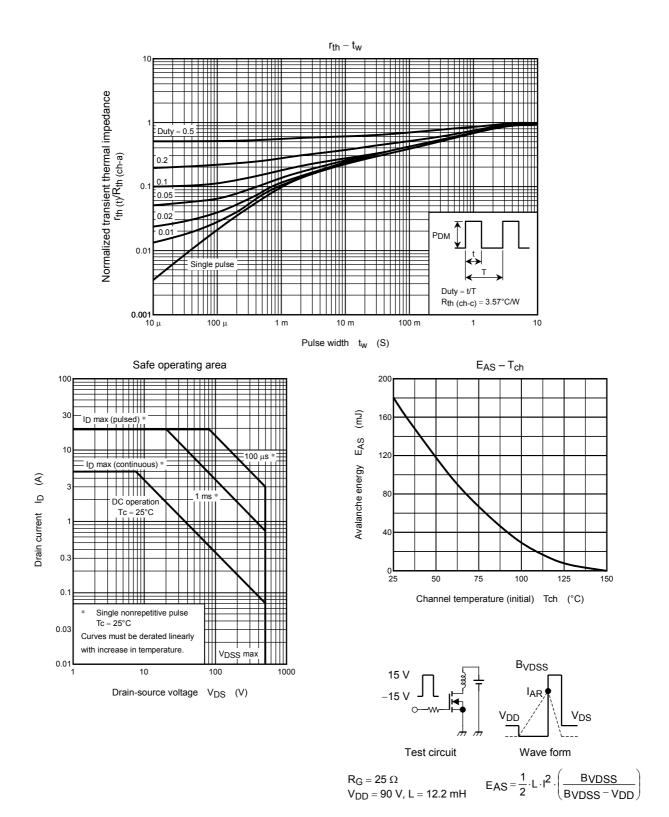












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